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Product Change Notification - JAON-17ZAMW740

Date: 10 Jun 2016
Product Category: Supertex
Notification subject: CCB 1709 Final Notice: Qualification of EFTEC-64T lead-frame for selected products in 8L VDFN (5x5x1.0mm) package at NSEB assembly site.
Notification text: **PCN Status:**
 Final notification

Microchip Parts Affected:

Please open the attachments found in the attachments field below labeled as PCN_#_Affected_CPN.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change:

Qualification of EFTEC-64T lead-frame for selected products in 8L VDFN (5x5x1.0mm) package at NSEB assembly site.

Pre Change:

C194 lead-frame material

Post Change:

EFTEC-64T lead-frame material

Pre and Post Change Summary:

	Pre Change	Post Change
Assembly Site	NSEB assembly site	NSEB assembly site
Wire material	Au wire	Au wire
Die attach material	8060T	8060T
Molding compound material	G770	G770
Lead frame material	C194	EFTEC-64T

Impacts to Data Sheet:
None

Reason for Change:
To improve on-time delivery performance by qualifying EFTEC-64T lead-frame material.

Change Implementation Status:
In Progress

Estimated First Ship Date:
July 9, 2016 (date code: 1627)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Summary Table:

	August 2015				--->	June 2016					July 2016			
	32	33	34	35		22	23	24	25	26	27	28	29	30
Initial PCN Issue Date				X										
Qual Report Availability						X								
Final PCN Issue Date						X								
Estimated Implementation Date										X				

Markings to Distinguish Revised from Unrevised Devices:
Traceability code

Revision History:
August 26, 2015: Issued initial notification.
June 10, 2016: Issued final notification. Attached the qualification report. Revised the estimated first ship date from November 15, 2015 to July 9, 2016.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):
[PCN_JAON-17ZAMW740_Qual_Report.pdf](#)
[PCN_JAON-17ZAMW740_Affected_CPN.pdf](#)
[PCN_JAON-17ZAMW740_Affected_CPN.xls](#)

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Affected Catalog Part Numbers (CPN)

PCN_JAON-17ZAMW740
CATALOG_PART_NBR
DN2625DK6-G